IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Mike G MacGregor

Title:

HEAT SINK ASSEMBLY AND METHOD OF ATTACHING A HEAT SINK TO AN

ELECTRONIC DEVICE ON A MOTHERBOARD

Docket No.:

884.940US1

Filed:

June 27, 2003

Examiner:

Corey M Broussard

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Serial No.: 10/607,783 Due Date: June 16, 2005 Group Art Unit: 2835

We are transmitting herewith the following attached items (as indicated with an "X"):

- X A return postcard.
- X An Amendment and Response Under 37 C.F.R. 1.111 (8 Pages).
- X Authorization to charge Deposit Account No. 19-073 in the amount of \$200.00 to cover the fee for additional claims as calculated below.
- X One formal drawing sheet.

If not provided for in a separate paper filed herewith, If an additional fee is required due to changes to the claims, the fee has been calculated as follows:

			CLAIMS AS	AMENDED		
	(1) Claims Remaining After Amendment		(2) Highest Number Previously Paid For	(3) Present Extra	Rate	Fee
TOTAL CLAIMS	20	-	20	0	x =	\$0.00
INDEPENDENT CLAIMS	4	-	3	1	x =	\$200.00
[]MULTIPLE DEPENDENT CLAIMS PRESENTED						\$0.00
TOTAL						\$200.00

Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

Atty: Ann M. McCrackin

mper. Ulas

Reg. No. 42,858

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450,

Alexandria, VA 22313-1450, on this **16** day of May, 2005.

_____*].*

Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A

(GENERAL)

0/607,783

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

pplicant:

Mike G MacGregor

Examiner: Corey M. Broussard

Serial No.:

10/607,783

Group Art Unit: 2835

Filed:

June 27, 2003

Docket No.: 884.940US1

Title:

HEAT SINK ASSEMBLY AND METHOD OF ATTACHING A HEAT SINK

TO AN ELECTRONIC DEVICE ON A MOTHERBOARD

Assignee:

Intel Corporation

Customer No: 21186

PROPOSED AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This paper responds to the Office Action mailed on March 16, 2005. Please amend the above-identified patent application as follows.

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